

Amendments to the Claims

This listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of Claims:

Claims 1-10 (Cancelled).

11. (New) A light emitting diode, comprising:
an element substrate;

a light emitting element mounted on the element substrate at rear surface thereof;

a translucent sealing body for sealing the light emitting element and having a plurality of light emitting surfaces capable of emitting light from the light emitting element in X, Y and Z axial directions; and

light shielding members attached only to top and bottom light emitting surfaces and configured to shield light emitted in the up and down Z axial direction from the top and bottom light emitting surfaces;

wherein light from the rear surface in the X axial direction is shielded by the element substrate,

wherein light from the light emitting element is emitted from the front light emitting surface and side light emitting surfaces to spread out in the X and Y axial directions.

12. (New) The light emitting diode according to claim 11,

wherein the sealing body has a trapezoidal shape in which the side light emitting surfaces incline inwardly toward the front light emitting surface so that light emitted from the side light emitting surfaces has forward directivity.

13. (New) A back light unit, comprising:

a mount substrate;

the light emitting diode as recited in claim 1 and mounted on a surface of the mount substrate; and

an optical wave-guide having a light receiving surface to face the front light emitting surface of the light emitting diode,

wherein at least one light emitting diode is disposed on the mount substrate so that light emitted from the at least one light emitting diode spreads out horizontally from the front light emitting surface and side light emitting surfaces on the sealing body towards the entire light receiving surface of the optical wave-guide.

14. (New) The back light unit according to claim 13,

wherein the front light emitting surface of the sealing body facing the light receiving surface of the optical

wave-guide is disposed to be generally in parallel with the light receiving surface of the optical wave-guide,

wherein the side light remitting surfaces of the sealing body are formed to incline toward inwardly toward the front light emitting surface.

15. (New) The back light unit according to claim 13,

wherein at least two light emitting diodes are mounted on the mount substrate,

wherein the light emitting diodes are disposed at an interval such that light emitted from the side light emitting surfaces of each of the light emitting diodes is disposed to be overlap as the light enters the light receiving surface of the optical wave-guide.

16. (New) The back light unit according to claim 13,

wherein the light emitting diode and the optical wave-guide are mounted on the mount substrate to be at a same level surface.